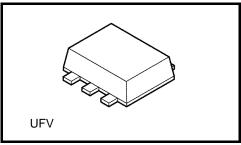
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TCS10DLU

### Digital-Output Magnetic Sensor

#### **Feature**

Open-Drain Output
South-Pole or North-Pole Detection

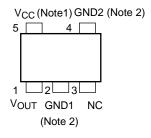


Weight: 0.007 g (typ.)

### Marking



### Pin Assignment (top view)



### **Function Table**

Magnetic Flux Density	Output		
$\geq B_{ON}$	L		
≤ B <sub>OFF</sub>	Z (Note 3)		

- Note 1: It is recommended to add a capacitor of about  $0.1 \mu F$  between Vcc and GND.
- Note 2: The GND1 and GND2 pins should be tied to ground. The GND2 pin is used as a test pin during production.
- Note 3: In the high-impedance state.

### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply Voltage	V <sub>CC</sub>	-0.5 to 6.0	V
Output Voltage	V <sub>OUT</sub> -0.5 to 6.0		٧
Output Diode Current	lok	-10	mA
Output Current	lout	5	mA
Vcc/GND Current	Icc	±10	mA
Power Dissipation	PD	200	mW
Storage Temperature Range	T <sub>stg</sub>	-65 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Operating Range**

Characteristics	Symbol	Rating	Unit
Supply Voltage	V <sub>CC</sub>	2.3 to 3.6	V
Output Voltage	V <sub>OUT</sub>	0 to 5.5 (Note 4)	V
Output Current	loL	1.0	mA
Operating Temperature	T <sub>opr</sub>	-40 to 85	°C

Note 4:  $V_{CC} = 0.0 \text{ V}$  or when the output is in the high-impedance state.

## DC Characteristics (Ta = 25°C)

Characteristics		Symbol	Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Output Voltage	Low- Level	V <sub>OL</sub>	I <sub>OL</sub> = 1.0 mA	2.3 to 3.6	_		V <sub>CC</sub> x 10%	٧
Output Leakage	e Current	loff	V <sub>OUT</sub> = 5.5V	0	_	0.5	1	μΑ
Supply Current	Average Current	1	Current at pulse driving	2.3 to 2.7	_	8.5	13.2	^
		(Note 5, Fig. A)	3.0 to 3.6	_	12.4	18.3	μА	
	Operating Current	I <sub>CC</sub> ON	Peak current (Note 5, Fig. A)	2.3 to 3.6	_	0.7	1.3	mA
Operating Frequency		f <sub>opr</sub>	(Fig. A)	2.3 to 3.6	_	25	_	Hz

Note 5: Supply Current is pulsed periodically by internal circuit.

### **Magnetic Characteristics (Ta = 25°C)**

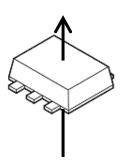
Ch	aracteristics	Symbol	Condition (Note 6, Fig. B)	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Magnetic – Flux Density	Operating Point	B <sub>ON</sub> S	V <sub>OUT</sub> = V <sub>OL</sub>	2.3 to 3.6	_	1.8	2.5	mT
		B <sub>ON</sub> N			-2.5	-1.8		
	Releasing Point	B <sub>OFF</sub> S	V <sub>OUT</sub> = Z (Note 7)	2.3 to 3.6	0.3	0.8		
		B <sub>OFF</sub> N			_	-0.8	-0.3	
	Hysteresis	BH	B <sub>ON</sub> - B <sub>OFF</sub>	2.3 to 3.6		1.0		

Note 6: Uniform magnetic field perpendicularly to the magnetic sensor.

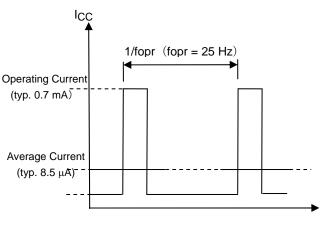
Note 7: In the high-impedance state.

Note: Direction of the Magnetic field

#### Magnetic Field, B

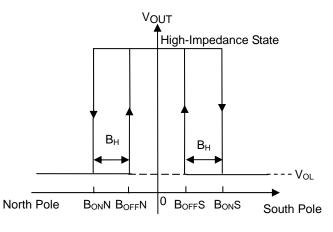


(Fig. A): I<sub>CC</sub> Characteristics



Time

(Fig. B): Operating Characteristics

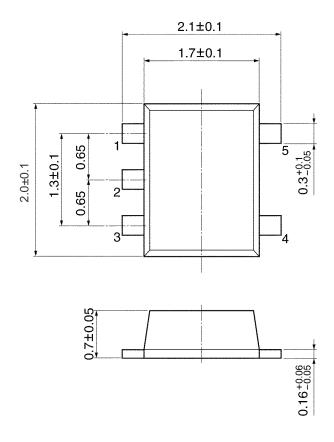


Magnetic Flux Density

3

# **Package Dimensions**

Unit: mm

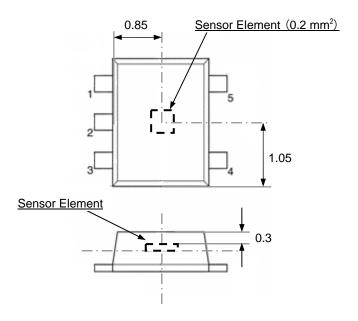


4

Weight: 0.007 g (Typ.)

# **Layout of Magnetic Detection Part**

Unit: mm



Note: Dimensional tolerances are  $\pm\,0.1\text{mm},$  unless otherwise specified.

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